Dual General Purpose Transistor

The MBT3906DW1T1 device is a spin-off of our popular SOT-23/SOT-323 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-363 six-leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low-power surface mount applications where board space is at a premium.

Features

- h_{FE}, 100-300
- Low $V_{CE(sat)}$, $\leq 0.4 \text{ V}$
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Available in 8 mm, 7-inch/3,000 Unit Tape and Reel
- Pb-Free Package is Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V _{CEO}	-40	Vdc
Collector - Base Voltage	V _{CBO}	-40	Vdc
Emitter - Base Voltage	V _{EBO}	-5.0	Vdc
Collector Current - Continuous	Ic	-200	mAdc
Electrostatic Discharge	ESD	HBM Class 2 MM Class B	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

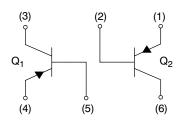
Characteristic	Symbol	Max	Unit
Total Package Dissipation (Note 1) T _A = 25°C	P _D	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	833	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.



ON Semiconductor®

http://onsemi.com





SOT-363/SC-88 CASE 419B STYLE 1

MARKING DIAGRAM



A2 = Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MBT3906DW1T1	SOT-363	3000 Units/Reel
MBT3906DW1T1G	SOT-363 (Pb-Free)	3000 Units/Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS	-	1		
Collector - Emitter Breakdown Voltage (Note 2)	V _{(BR)CEO}	-40	_	Vdc
Collector - Base Breakdown Voltage	V _{(BR)CBO}	-40	_	Vdc
Emitter - Base Breakdown Voltage	V _{(BR)EBO}	-5.0	-	Vdc
Base Cutoff Current	I _{BL}	-	-50	nAdc
Collector Cutoff Current	I _{CEX}	-	-50	nAdc
ON CHARACTERISTICS (Note 2)	•			
DC Current Gain $ \begin{aligned} &(I_C = -0.1 \text{ mAdc, } V_{CE} = -1.0 \text{ Vdc)} \\ &(I_C = -1.0 \text{ mAdc, } V_{CE} = -1.0 \text{ Vdc)} \\ &(I_C = -10 \text{ mAdc, } V_{CE} = -1.0 \text{ Vdc)} \\ &(I_C = -50 \text{ mAdc, } V_{CE} = -1.0 \text{ Vdc)} \\ &(I_C = -100 \text{ mAdc, } V_{CE} = -1.0 \text{ Vdc)} \end{aligned} $	h _{FE}	60 80 100 60 30	- 300 - -	-
Collector – Emitter Saturation Voltage ($I_C = -10$ mAdc, $I_B = -1.0$ mAdc) ($I_C = -50$ mAdc, $I_B = -5.0$ mAdc)	V _{CE(sat)}	- -	-0.25 -0.4	Vdc
Base – Emitter Saturation Voltage ($I_C = -10$ mAdc, $I_B = -1.0$ mAdc) ($I_C = -50$ mAdc, $I_B = -5.0$ mAdc)	V _{BE(sat)}	-0.65 -	-0.85 -0.95	Vdc
SMALL-SIGNAL CHARACTERISTICS				
Current - Gain - Bandwidth Product	f _T	250	_	MHz
Output Capacitance	C _{obo}	-	4.5	pF
Input Capacitance	C _{ibo}	-	10.0	pF

^{2.} Pulse Test: Pulse Width \leq 300 μ s; Duty Cycle \leq 2.0%.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Continued)

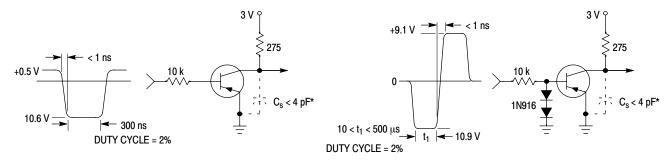
 $(I_{B1} = I_{B2} = -1.0 \text{ mAdc})$

Fall Time

	Characteristic	Symbol	Min	Max	Unit	
Input Impedance (V _{CE} = -10 Vdc	s, I _C = -1.0 mAdc, f = 1.0 kHz)	h _{ie}	2.0	12	kΩ	
Voltage Feedback (V _{CE} = -10 Vdc	Ratio ; I _C = -1.0 mAdc, f = 1.0 kHz)	h _{re}	0.1	10	X 10 ⁻⁴	
Small - Signal Cur (V _{CE} = -10 Vdc	rent Gain ;, I _C = -1.0 mAdc, f = 1.0 kHz)	h _{fe}	100	400	-	
Output Admittance (V _{CE} = -10 Vdc	e r, I _C = -1.0 mAdc, f = 1.0 kHz)	h _{oe}	3.0	60	μmhos	
Noise Figure (V _{CE} = -5.0 Vde	c, I _C = -100 μAdc, R _S = 1.0 k Ω, f = 1.0 kHz)	NF	-	4.0	dB	
SWITCHING CH	ARACTERISTICS	•	•	•		
Delay Time	$(V_{CC} = -3.0 \text{ Vdc}, V_{BE} = 0.5 \text{ Vdc})$	t _d	-	35		
Rise Time	(I _C = -10 mAdc, I _{B1} = -1.0 mAdc)	t _r	-	35	ns	
Storage Time	$(V_{CC} = -3.0 \text{ Vdc}, I_C = -10 \text{ mAdc})$	t _s	-	225		
	i		1	1	ns	

ns

75



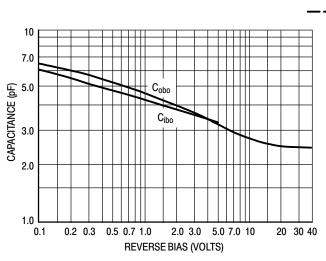
* Total shunt capacitance of test jig and connectors

Figure 1. Delay and Rise Time Equivalent Test Circuit

Figure 2. Storage and Fall Time Equivalent Test Circuit

TYPICAL TRANSIENT CHARACTERISTICS

- T_J = 25°C





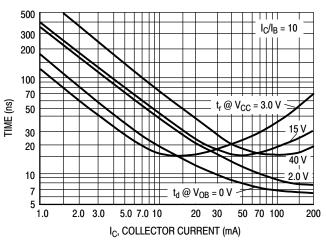


Figure 5. Turn-On Time

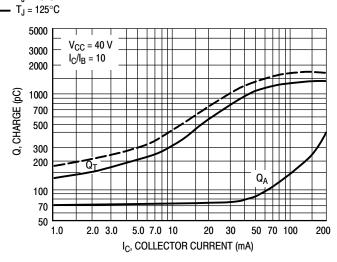


Figure 4. Charge Data

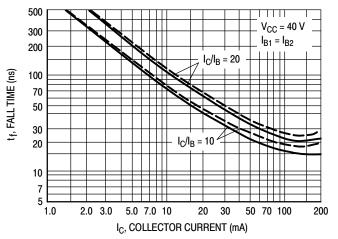
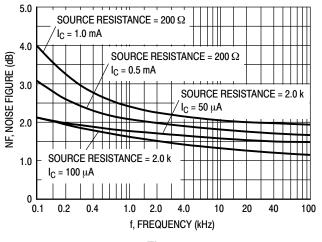


Figure 6. Fall Time

TYPICAL AUDIO SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE VARIATIONS

 $(V_{CE} = -5.0 \text{ Vdc}, T_A = 25^{\circ}\text{C}, Bandwidth = 1.0 \text{ Hz})$



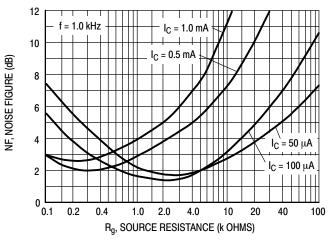
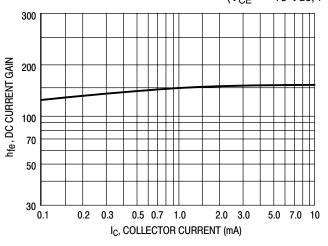


Figure 7.

Figure 8.

h PARAMETERS

 $(V_{CE} = -10 \text{ Vdc}, f = 1.0 \text{ kHz}, T_A = 25^{\circ}\text{C})$



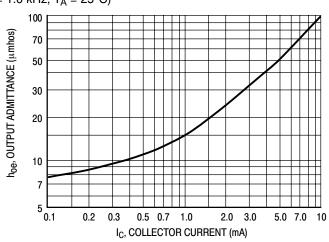
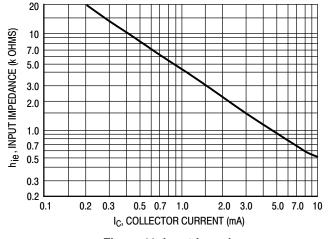


Figure 9. Current Gain

Figure 10. Output Admittance



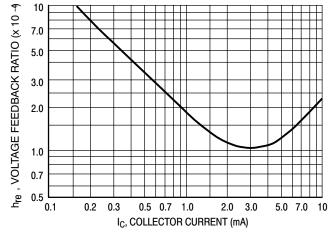


Figure 11. Input Impedance

Figure 12. Voltage Feedback Ratio

TYPICAL STATIC CHARACTERISTICS

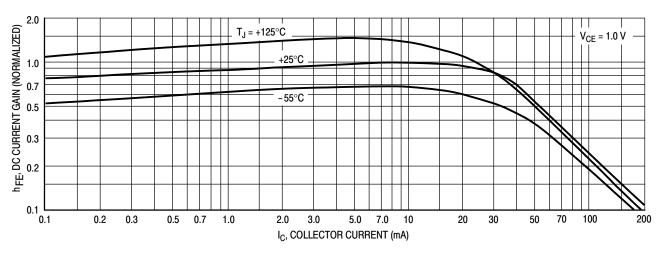


Figure 13. DC Current Gain

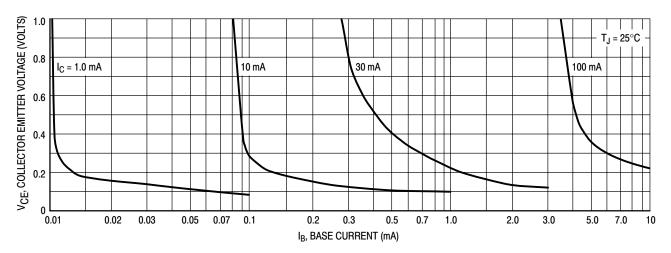


Figure 14. Collector Saturation Region

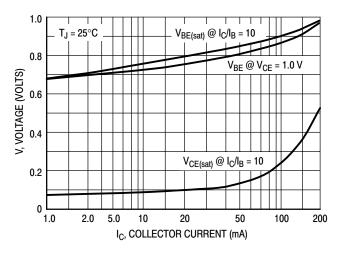


Figure 15. "ON" Voltages

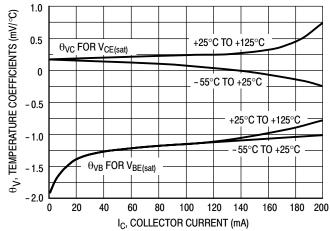
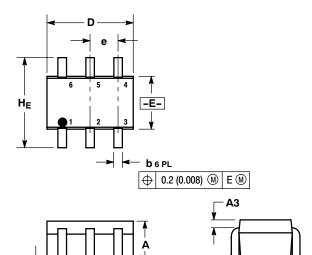


Figure 16. Temperature Coefficients

PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363 CASE 419B-02 ISSUE W



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
- 2. CONTROLLING DIMENSION: INCH.
- 3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

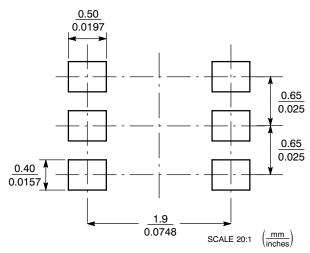
	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.80	0.95	1.10	0.031	0.037	0.043	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
А3		0.20 REF			0.008 REF		
b	0.10	0.21	0.30	0.004	0.008	0.012	
C	0.10	0.14	0.25	0.004	0.005	0.010	
D	1.80	2.00	2.20	0.070	0.078	0.086	
Е	1.15	1.25	1.35	0.045	0.049	0.053	
е		0.65 BS	65 BSC		.026 BS	С	
L	0.10	0.20	0.30	0.004	0.008	0.012	
Н	2.00	2.10	2.20	0.078	0.082	0.086	

STYLE 1: PIN 1. EMITTER 2

- 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1

- 6. COLLECTOR 2

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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